



Technology Unites GLOBAL SUMMIT

FEB 15-19 2021 | DIGITAL EVENT

POST SHOW REPORT

Shaping the Digital Future

@SEMIEurope

#TechnologyUnites

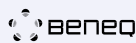


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PLATINUM SPONSORS



GOLD SPONSORS



SILVER SPONSORS



EVENT SPONSORS



KEY FIGURES

50 
COUNTRIES

1679 
INTERNATIONAL
ATTENDEES

57 
EXHIBITORS

41 
SPONSORS

42 
HOURS OF
PROGRAMS

28 
EXECUTIVE
SPEAKERS

180 
SPEAKERS &
CONTRIBUTORS

225 
STUDENTS

25 
PRESS
ATTENDEES

55 
MEDIA
PARTNERS

215 
JOB POSTS

7 PAVILIONS

EUROPE

AMERICAS

TAIWAN

CHINA

JAPAN

SOUTH
KOREA

SOUTH
EASTH ASIA

8 FORUMS

EXECUTIVE FORUM

**EU DIGITAL
FUTURE FORUM**

**MEMS & IMAGING
SENSORS FORUM**

**SMART MOBILITY
FORUM**

**ADVANCED
PACKAGING FORUM**

**FAB MANAGEMENT
FORUM**

DIVERSITY FORUM

**SMART MEDTECH
FORUM**

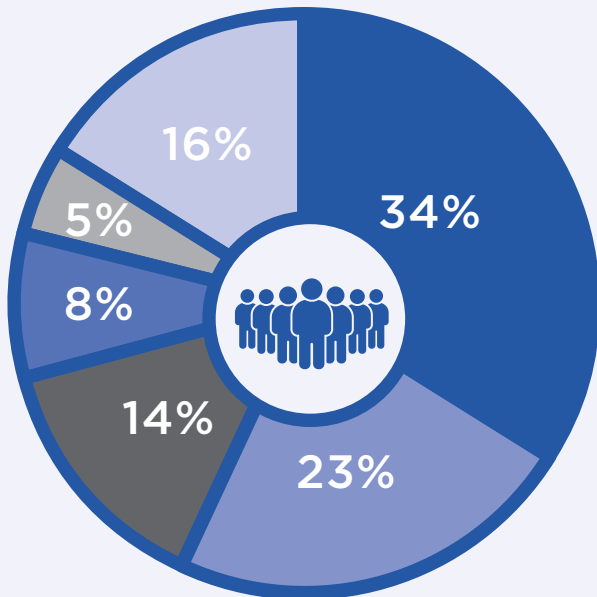
“ Thank you again for the support and collaboration with the virtual event which was very successful to us. We have received positive feedbacks and interesting leads. ”

Daffy Yancu. Yaskawa Europe Technology Ltd.

YASKAWA

ATTENDEE DEMOGRAPHICS

- **Germany 34%**
- **United States 23%**
- **United Kingdom 14%**
- **France 8%**
- **Belgium 5%**



- **Other 16%**

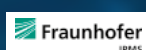
Netherlands	Canada	Liechtenstein
Switzerland	Russian Federation	Sweden
Austria	Turkey	Cyprus
Japan	Czech Republic	Algeria
Finland	Portugal	Indonesia
Korea	Spain	Philippines
Italy	Denmark	Iran
Israel	Malaysia	Colombia
Saudi Arabia	Norway	Lebanon
Taiwan	Hungary	Brazil
Singapore	Albania	Greece
Ireland	Australia	Peru
India	Hong Kong	Paraguay
Argentina	Poland	Malta
China	Kuwait	

KEY ATTENDING COMPANIES

Advantest | Air Liquide | Airspace | Amkor
 Technology | ams | AP&S International GmbH
 Applied Materials | ARM Inc. | ASE Group | ASM
 International | ASML | Atotech | Axcelis Techno-
 logies | BASF SE | Beneq Oy | BESI | Bosch |
 Brewer Science | Busch Vacuum Solutions |
 Canon Europa N.V. | Carl Zeiss SMT GmbH | CEA
 Leti | centrotherm Singapore | COMET Group |
 Coventor - A Lam Research Company | Crocus
 Nano Electronics | CyberOptics Corporation |
 DAS Environmental Expert GmbH | EBARA
 CORPORATION | Edwards Vacuum | EMD
 Performance Materials | Entegris | Eumetrys |
 European Commission | EV Group (EVG) | Evatec
 | Fabmatics | Facebook | FastMicro B.V. |
 Fraunhofer Institutes | FUJIFILM Electronic
 Materials | GE Digital | GLOBALFOUNDRIES |
 Hamamatsu Photonics | Henkel | Hitachi ABB
 Power Grids | HUAWEI | IBM Research | IC'Alps
 | imec | INFICON | Infineon Technologies |
 Intel | Jipal corporation | JSR Micro NV | KAUST -
 Nanofabrication Core Lab | KLA | Kokusai
 Semiconductor Europe GmbH | Lam Research |
 McKinsey & Company | Mentor, a Siemens business
 | Merck KGaA | Mitsubishi Chemical Semicon-
 ductor Solutions | Murata Electronics | Nikon |
 Nippon Electric Glass Co.,Ltd. | Nova Measuring
 Instruments | NXP Semiconductors | Okmetic Oy
 | ON Semiconductor | Orbotech (a KLA company)
 | Osram | Peer Group | Pfeiffer Vacuum |
 Picosun Oy | RENA Techno-logies GmbH | Robert
 Bosch GmbH | Samsung Semiconductor Europe
 GmbH | SCREEN Semiconductor Solutions Co.,
 Ltd. | Semics | Siconnex customized solutions
 GmbH | Siemens Healthcare GmbH | Solmates |
 SPEA | SPTS Technologies (A KLA Company) |
 ST Microelectronics | SÜSS Microtec | TATA STEEL
 | Thermo Fisher Scientific | Tokyo Electron |
 Trelleborg Sealing Solutions | TRUMPF | Trymax
 Semiconductor Equipment BV | TSMC | Umicore
 | UTAC | VAT Group | Volkswagen AG |
 VTT | YASKAWA Europe Technology Ltd. |
 Yole Développement

“The event and the virtual booth were a good opportunity to connect with potential partners and customers to promote our activities, the hosted session, content, but also job vacancies.”

Sandra Maria and Huyen. Fraunhofer Institute for Photonic Microsystems IPMS

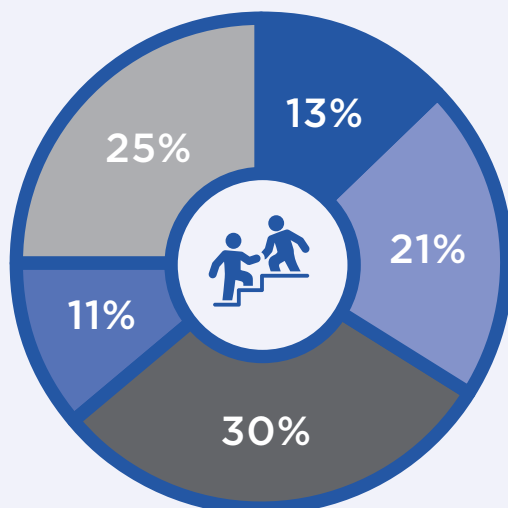


INTERNATIONAL ACADEMIC INSTITUTES

Aalborg University | Aalto University | ACM Research Inc | Auburn University | Australian Institute for Bioengineering and Nanotechnology | Barkhausen Institut | Brunel University London | Christ University | City College of San Francisco | Duale Hochschule Baden-Württemberg | Duke University | Facultad Regional Buenos Aires UTN | Gent University | Georgia Institute of Technology | Graz University of Technology | Hochschule Aalen | Htw Berlin | Imperial College London | Indian Institute of Science (IISc) | KAUST - Nanofabrication Core Lab | Keio University | King Abdullah University of Science and Technology | King Fahd University of Petroleum and Mi | KU Leuven | Northwestern University | Ohio University | Penn State University | Portland State University | Purdue University | Queen Mary University of London | Ruhe-Universität Bochum | San Jose State University | Shinshu University | Soongsil University | Southern Methodist University St Joseph Engineering College | Swansea University | TU Dresden | TU Graz | TU Ilmenau | TU Wien | Uludag University | Universidad Nacional de Colombia | Universidad Tecnológica Nacional | Universidade do Minho | Universitas Pertamina | Universität Rostock | Universität Stuttgart | Universiteit Utrecht | University College London | University of Arizona | University of Aveiro | University of Calgary | University of Cambridge | University of Freiburg | University of Maine at Augusta | University of Minho | University of Strasbourg | University of York | Vellore Institute of Technology | Yonsei University School of Electrical and Electronic Engineering

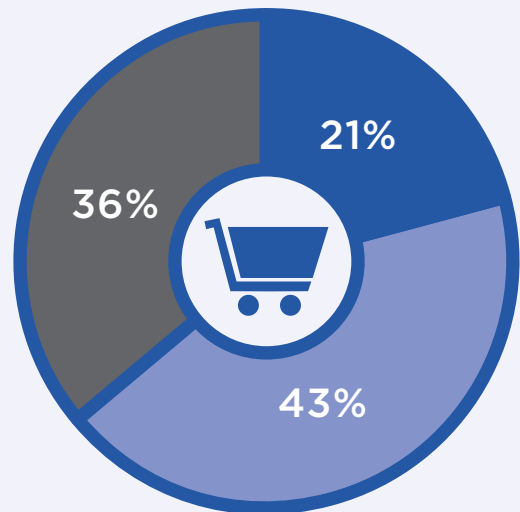
JOB LEVEL

- **Executive 13%**
- **Senior management 21%**
- **Professional / Engineer / Staff 30%**
- **Student 11%**
- **Other management 25%**



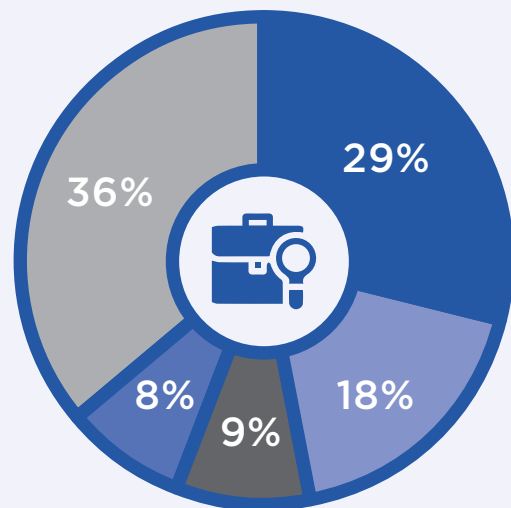
PURCHASING AUTHORITY

- **Final decision maker 21%**
- **Recommend / Evaluate 43%**
- **Other 36%**



JOB AREA

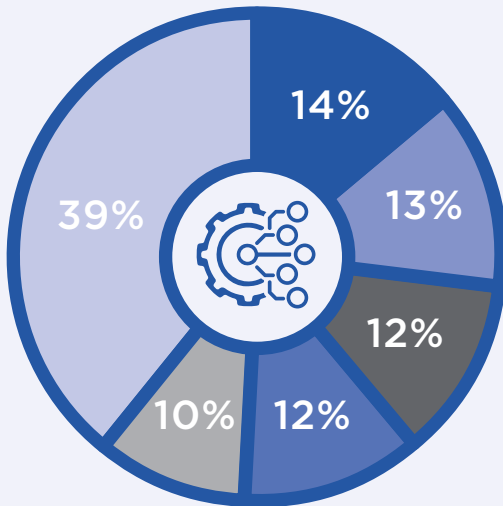
- **Marketing, Sales, Business Development 29%**
- **R&D 18%**
- **Executive Management 9%**
- **Product Management 8%**



- **Other 36%**
- Fabrication and Process Engineering
- Human Resources / Training / Education
- Equipment Engineering
- Software Engineering
- Manufacturing / Operations Management / Production
- Chemicals / Materials
- Design
- Financial / Industry Analyst / Investor Relations
- EHS
- Facilities / Engineering Support
- Government / Public Policy
- Industrial Engineering
- Logistics / Supply Chain Management
- Packaging / Assembly
- Test

APPLICATIONS

- Virtual Reality / Augmented Reality (VR/AR) 14%
- Internet of Things (IoT) 13%
- Automotive Electronics / Smart Transportation 12%
- Consumer Electronics / Wearables 12%
- Artificial Intelligence Systems (AI) 10%

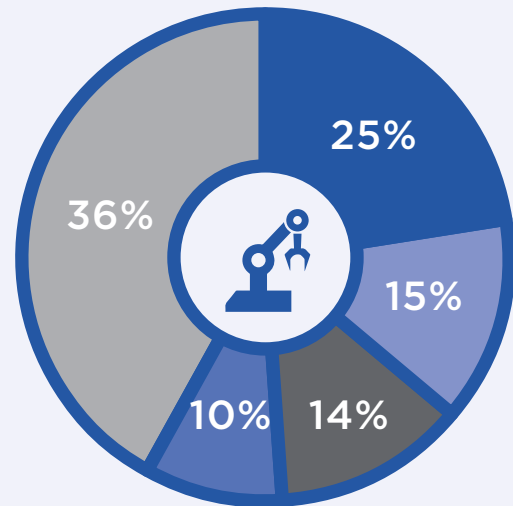


Other 39%

- Mobile Technologies / Wireless / 5G
- Imaging / OLED
- Medical Electronics / MedTech
- Other Applications
- Smart Manufacturing
- Cloud Computing / High-Performance Computing
- Green Manufacturing / EHS

MANUFACTURING TECHNOLOGIES

- Front-end Manufacturing (IDM, Foundry) 25%
- Packaging / Assembly 15%
- Material Engineering / Materials Science 14%
- System Integration / Product-level Manufacturing 10%

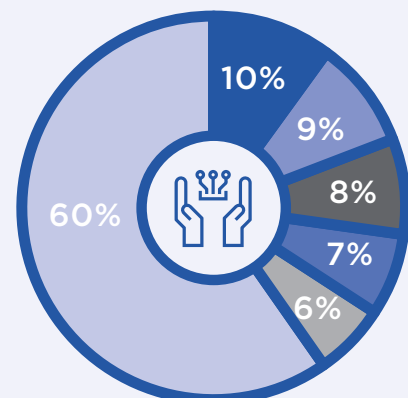


Other 36%

- Test
- Design / EDA / IP
- System-level Manufacturing
- Board-level Manufacturing
- Roll-to-Roll / Printing

PRODUCT AND SERVICES

- Foundries 10%
- Front-end Processing 9%
- ER&D / Technology Transfer 8%
- Packaging & Test Services (OSAT) 7%
- Electronic Manufacturing Services (EMS) / System Integration 6%
- Other 60%



- Design / EDA
- Wafers / Substrates
- Inspection & Measurement / Metrology
- Assembly / Packaging
- Fabless
- Factory Control / Process Software
- Large-area / Thin Film
- Manufacturing Services and Consulting
- Process Materials: Gases / Liquids / Solids / Chemicals
- Abatement / Environmental Systems
- Engineering Services
- Factory Automation / Robotics
- Packaging / Assembly
- Test
- Cleaning
- Components / Sub-systems / Instrumentation
- Consumables
- General Business Services / Consulting
- Inks / Pastes / Printing Materials
- Other Design / Manufacturing Services
- Other Manufacturing Equipment
- Other Materials
- Parts
- Printing / Coating / Roll-to-Roll
- Representative Sales and Service
- Secondary Equipment and Services
- Standards
- Support Products / Cleanroom
- Other

PARTICIPATING EXHIBITORS



MEDIA PARTNERS



“The virtual summit showed that despite the challenges of the pandemic we can still have valuable exchanges. Thank you to SEMI to organise the event.”

Eyal Shekel, Senior VP Service Strategy & Excellence, Tokyo Electron Ltd.

